V2P22

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Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



Anode O Cathode

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	2.0 A			
V _{RRM}	200 V			
I _{FSM}	30 A			
V _F at I _F = 2.0 A (125 °C)	0.70 V			
T _J max.	175 °C			
Package	MicroSMP (DO-219AD)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 0.65 mm
- Trench MOS Schottky technology
- Low forward voltage drop
- Low power loss, high efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications, in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: MicroSMP (DO-219AD) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, and RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V2P22	UNIT	
Device marking code		V2D		
Maximum repetitive peak reverse voltage	V _{RRM}	200	V	
Maximum DC reverse voltage	V _{DC}	160	V	
Maximum average forward rectified current	I _{F(AV)} ⁽¹⁾	1.5	А	
	I _{F(AV)} ⁽²⁾	2	А	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30	A	
Operating junction temperature range	T _J ⁽³⁾	-40 to +175	°C	
Storage temperature range	T _{STG}	-55 to +175	°C	

Notes

⁽¹⁾ Free air mounted on recommended copper pad area

⁽²⁾ Mounted on 8 mm x 8 mm copper pad area PCB

 $^{(3)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{0JA}$

Revision: 03-Aug-2020

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Document Number: 86536

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HALOGEN

FREE

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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage	I _F = 1.0 A	T _A = 25 °C	V _F ⁽¹⁾	0.78	-	- V	
	I _F = 2.0 A			0.85	0.93		
	I _F = 1.0 A	T _A = 125 °C		0.63	-		
	I _F = 2.0 A			0.70	0.78		
Reverse current	V _R = 160 V	T _A = 25 °C	I _R ⁽²⁾	0.001	-	- mA	
		T _A = 125 °C		0.1	-		
	V _R = 200 V	T _A = 25 °C		-	0.035		
		T _A = 125 °C		0.3	1.5		
Typical junction capacitance	4.0 V, 1 MHz		CJ	60	-	pF	

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 5 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER SYMBO		V2P22	UNIT	
Typical thermal resistance	R _{0JA} (1)(2)	130	°C/W	
	R _{0JM} ⁽³⁾	20		

Notes

⁽¹⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

 $^{(2)}$ Free air, mounted on recommended copper pad area; thermal resistance, $R_{\theta JA}$ - junction to ambient

 $^{(3)}$ Mounted on 8 mm x 8 mm copper pad area PCB; thermal resistance, $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V2P22-M3/H	0.006	Н	4500	7" diameter plastic tape and reel	
V2P22HM3/H ⁽¹⁾	0.006	Н	4500	7" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

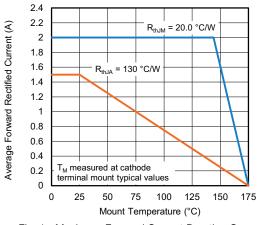


Fig. 1 - Maximum Forward Current Derating Curve

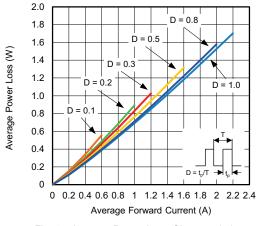


Fig. 2 - Average Power Loss Characteristics

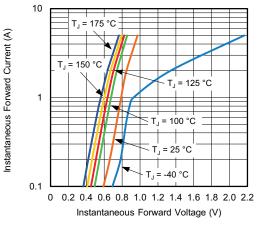


Fig. 3 - Typical Instantaneous Forward Characteristics

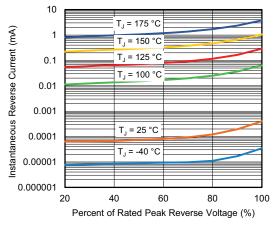
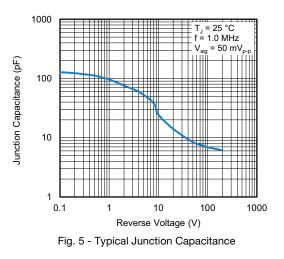


Fig. 4 - Typical Reverse Leakage Characteristics



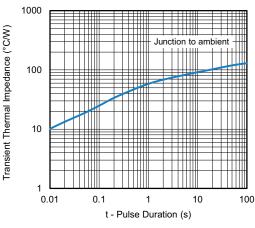


Fig. 6 - Typical Transient Thermal Impedance

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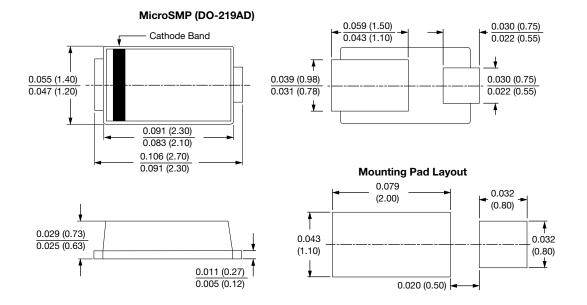
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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